



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| BV _{DSS} | R _{DS(ON)} | I _D T _A = +25°C |
|-------------------|-----------------------------|------------------------------------------|
| 30V | 5Ω @ V _{GS} = 4V | 200mA |
| 307 | 7Ω @ $V_{GS} = 2.5V$ | 115mA |

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Brushless DC Motor Control
- **DC-DC Converters**
- Load Switch

Features

- N-Channel MOSFET
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate 2KV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN33D8LTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

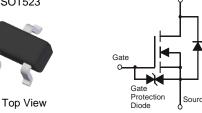
https://www.diodes.com/quality/product-definitions/

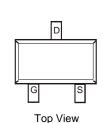
Mechanical Data

- Case: SOT523
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed Over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208@3
- Terminal Connections: See Diagram
- Weight: 0.002 grams (Approximate)









Equivalent Circuit

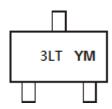
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|---------------|--------|--------------------|
| DMN33D8LTQ-7 | SOT523 | 3,000/Tape & Reel |
| DMN33D8LTQ-13 | SOT523 | 10,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



3LT = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020)M = Month (ex: 9 = September)

Date Code Kev

| Year | 2018 | 2019 | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | F | G | Н | - 1 | J | K | L | М | N | 0 | Р | R |
| Month | lon | Feb | Man | Amr | Marr | | 11 | A | 0 | | | |
| WOITH | Jan | reb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|------------------------|------------|------------------|-------|------|
| Drain-Source Voltage | | VDSS | 30 | V |
| Gain-Source Voltage | | V _{GSS} | ±20 | V |
| Drain Current (Note 5) | Continuous | ID | 115 | mA |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--------------------------------------------------|----------|-------------|------|
| Total Power Dissipation (Note 5) | PD | 240 | mW |
| Thermal Resistance, Junction to Ambient (Note 5) | RθJA | 521 | °C/W |
| Total Power Dissipation (Note 6) | PD | 300 | mW |
| Thermal Resistance, Junction to Ambient (Note 6) | RθJA | 420 | °C/W |
| Operating and Storage Temperature Range | TJ, TSTG | -55 to +150 | °C |

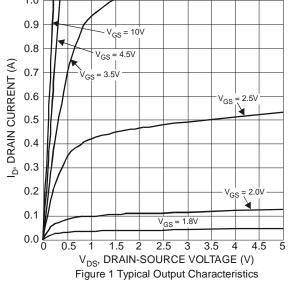
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

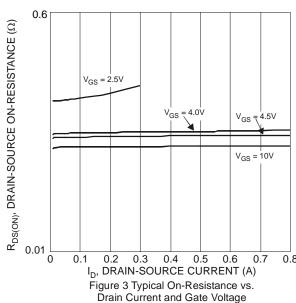
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | | |
|--------------------------------------------|---------------------|-----|------|-----|-------|-----------------------------------------------------------------------|--|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 30 | _ | _ | V | $V_{GS} = 0V, I_D = 250\mu A$ | | |
| Zero Gate Voltage Drain Current | I _{DSS} | | _ | 1.0 | μΑ | V _{DS} = 30V, V _{GS} = 0V | | |
| Gate-Body Leakage | Igss | | _ | ±10 | μΑ | V _G S = ±20V, V _D S = 0V | | |
| ON CHARACTERISTICS (Note 7) | | | | | | | | |
| Gate Threshold Voltage | Vgs(TH) | 0.8 | _ | 1.5 | V | $V_{DS} = 3V, I_{D} = 100\mu A$ | | |
| Static Drain-Source On-Resistance | D- 2/2/3 | | _ | 5 | Ω | V _G S = 4V, I _D = 10mA | | |
| Static Drain-Source On-Resistance | RDS(ON) | | _ | 7 | Ω | V _G S = 2.5V, I _D = 5mA | | |
| Diode Forward Voltage | VsD | _ | _ | 1.2 | V | V _G S = 0V, I _S = 115mA | | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | | |
| Input Capacitance | Ciss | | 48 | | | V _{DS} = 5V, V _{GS} = 0V, f = 1.0MHz | | |
| Output Capacitance | Coss | | 11 | | pF | | | |
| Reverse Transfer Capacitance | Crss | _ | 8 | _ | | | | |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | _ | 0.55 | _ | | | | |
| Total Gate Charge (V _{GS} = 10V) | Qg | | 1.23 | _ | nC | Vgs = 10V, Vps = 10V, | | |
| Gate-Source Charge | Qgs | | 0.14 | | nc nc | ID = 250mA | | |
| Gate-Drain Charge | Q_{gd} | | 0.14 | | | | | |
| Turn-On Delay Time | t _D (ON) | | 2.9 | _ | | | | |
| Turn-On Rise Time | tR | | 2.6 | _ | ns | V _{DD} = 30V, I _D = 0.2A, V _{GEN} = 10V, | | |
| Turn-Off Delay Time | tD(OFF) | | 18.2 | | 115 | $R_{GEN} = 25\Omega$ | | |
| Turn-Off Fall Time | tF | | 13.6 | _ | | | | |

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect. Notes:

^{8.} Guaranteed by design. Not subject to product testing.







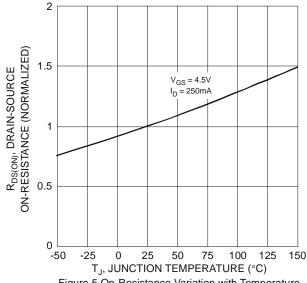
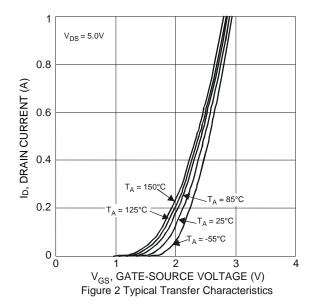


Figure 5 On-Resistance Variation with Temperature



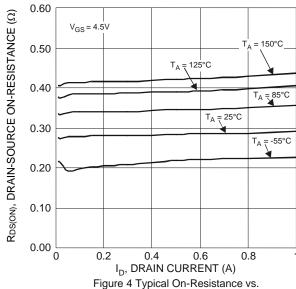


Figure 4 Typical On-Resistance vs Drain Current and Temperature

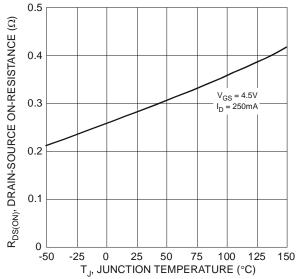


Figure 6 On-Resistance Variation with Temperature



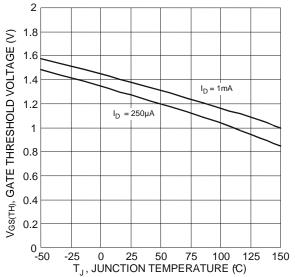
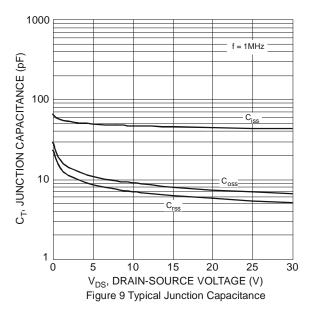
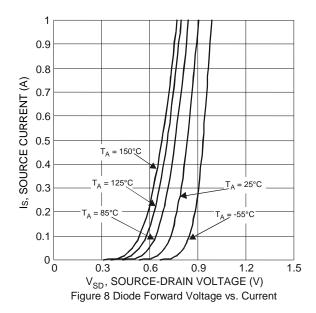
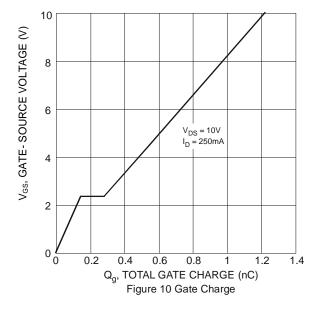


Figure 7 Gate Threshold Variation vs. Junction Temperature





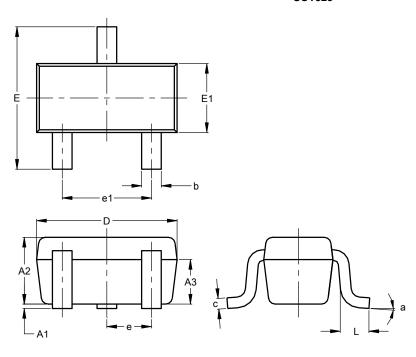




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523

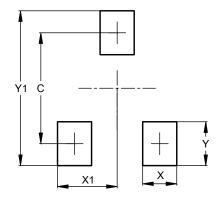


| SOT523 | | | | | | | |
|----------------------|----------|------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| A1 | 0.00 | 0.10 | 0.05 | | | | |
| A2 | 0.60 | 0.80 | 0.75 | | | | |
| А3 | 0.45 | 0.65 | 0.50 | | | | |
| b | 0.15 | 0.30 | 0.22 | | | | |
| С | 0.10 | 0.20 | 0.12 | | | | |
| D | 1.50 | 1.70 | 1.60 | | | | |
| Е | 1.45 | 1.75 | 1.60 | | | | |
| E1 | 0.75 | 0.85 | 0.80 | | | | |
| е | 0.50 BSC | | | | | | |
| e1 | 0.90 | 1.10 | 1.00 | | | | |
| L | 0.20 | 0.40 | 0.33 | | | | |
| а | 0° | | 8° | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523



| Dimensions | Value (in mm) |
|------------|------------------|
| С | 1.29 |
| Х | 0.40 |
| X1 | 0.70 |
| Y | 0.51 |
| Y1 | 1.80 |



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